



Secure Device Forum 2024 (V3.0, 2024.2.16)

日時: 13:00-17:50 (JST) February 16, 2024

Place: Online

Host:

GlobalPlatform (GP) Japan Task Force

Next Generation IC Card System Study Group (NICSS)

Objectives:

In response to supply chain issues, zero trust / RoT (Root of Trust), and the full-fledged installation of public APs in mobile devices, device security evaluation certification / Software Bill of Materials (SBOM) support and high reliability are being implemented worldwide. Trusted Execution Environment (TEE), digital ID, etc. are becoming important security initiatives for mobile / consumer devices.

This year, we will discuss the latest trends in consumer device security, including international standardization, Government and Domestic initiatives, and explore prospects for future developments related to secure components and devices.

Theme:

Trends in Consumer Device Security

Program::

13:00-13:20 Opening

- (Overall trends, Secure Device Forum 2024 objectives)
 Trends in Consumer Device Security Evaluation & Certification, TEE and Digital ID
 - Eikazu Niwano (NTT)
 Chair of Secure Device Forum 2024 / Board of Directors and Chair of Japan Task Force, GlobalPlatform

13:20-14:00 International standardization

(GlobalPlatform initiatives)

Latest status of GlobalPlatform

♦ Ana Lattibeaudiere

Executive Director. GlobalPlatform

Post Quantum crypto migration, Automotive requirements and impact on the GlobalPlatform road map

♦ Gil Bernabeu

Chief Technology Officer, GlobalPlatform

14:00-15:00 Government initiatives

(Cyber security initiatives①)
 Update on cybersecurity projects at MIC

Counselor, Office of Director-General for Cybersecurity, Ministry of Internal Affairs and Communications

• (Cyber security initiatives 2)

Overview of Cyber Security Policy and Status of Study for Establishment of IoT Product Conformity Assessment System

→ Taketo Yamada

Director for Cybersecurity Strategy, Cybersecurity Division, Commerce and Information Policy Bureau, Minister of Economy, Trade and Industry

15:00-15:30 Break

15:30-16:30 Evaluation and Certification

(Connected Consumer Device Security Council (CCDS) initiatives)
 IoT labeling program launched! -Digital Equipment Regulatory Status-

→ Tsukasa Ogino

Representative Director, Connected Consumer Device Security Council

• (ECSEC Laboratory initiatives)

IoT Platform Evaluation - Introduction of SESIP

♦ Masanori Matsumoto,
 General Manager, Technical Center, ECSEC Laboratory

16:30-17:00 Trusted Execution Environments (TEE)

• (Trusted Execution Environments implementation status)

TEE use cases in different type of devices

♦ Kenji Takahashi TRUSTONIC Business Development, Japan

17:00-17:30 Digital ID (International standardization)

(ISO initiative status, etc.)

Status of Development of International Standards for Personal Identification and Authentication on Mobile Devices and Use of Secure Devices

♦ Masuyoshi Yachida (Tokyo Institute Technology)
 National Committee Vice Chair, ISO/IEC JTC1 SC17 / Next-generation IC
 Card System Study Group

17:30-17:50 Closing

- (Summary, Perspective)
 - ♦ Nagaaki Ohyama (Tokyo Institute Technology)
 Chairman, Next-generation IC Card System Study Group
 - → Takashi Obi (Tokyo Institute Technology)
 Board member, Next-generation IC Card System Study Group

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* The content, time and speakers may change in the future.